



PRODUCT SERIES NAME: A1004 SERIES-SMT TYPE

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#### 1.SCOPE:

This specification covers the requirements for product performance of 1.00mm pitch wire to board connector series.

#### 2.CONSTRUCTION · DIMENSIONS · MATERIAL & PLATING:

See the attached drawings

#### **3.RATINGS & APPLICABLE WIRES:**

Item	Standard		
Rated Voltage (max.)	100V AC, DC		
Rated Current (max.)	AWG #28	1A AC, DC	Insulation O.D.
and Applicable Wires	AWG #30	0.9A AC, DC	0.60mm (max.)
	AWG #32	0.8A AC, DC	
Ambient Temperature Range	-25°C ~ +85°C*		

<sup>\*:</sup> Including terminal temperature rise

#### **4.PERFORMANCE:**

#### 4-1.ELECTRICAL PERFORMANCE

Test Description		Procedure	Requirement	
4-1-1	Contact	Mate connectors, measure by dry circuit, 20mV max.	30mΩ max.	
	Resistance	10mA. (Based upon JIS C5402 5.4)		
4-1-2	Insulation	Mate connectors, apply 500V DC between adjacent		
	Resistance	terminal or ground. (Based upon JIS C5402 5.2/	$500 M\Omega$ min.	
		MIL-STD-202 Method 302 Cond. B)		
4-1-3	Dielectric	Mate connectors, apply 500V AC (rms) for 1 minute		
	Withstanding	between adjacent terminal or ground. (Based upon	No Breakdown	
	Voltage	JIS C5402 5.1/MIL-STD-202 Method 301)		
4-1-4	Contact	Crimp the applicable wire on to the terminal, measure		
	Resistance	by dry circuit, 20mV max., 10mA.	5mΩ max.	
	on Crimped		JIIISZ IIIAX.	
	Portion			

			APPROVED	CHECKED	WRITTEN
			BY	BY	BY
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#### **4-2.MECHANICAL PERFORMANCE**

Test Description		Procedure		Requirement
4-2-1	Insertion & Withdrawal Force	Insert and withdraw connectors at the speed rate of $25 \pm 3$ mm/minute.		Refer to paragraph 5
4-2-2	Fix the crimped terminal, apply axial pull out force on the wire at the speed		AWG #28	1.0kgf min.
	Pull Out Force	rate of $25 \pm 3$ mm/minute. (Based upon JIS C5402 6.8)	AWG #30	0.8kgf min.
			AWG #32	0.5kgf min.
4-2-3	Terminal Insertion Force	Insert the crimped terminal into the housing.		0.5kgf max.
4-2-4	Terminal/ Housing Retention Force	Apply axial pull out force at the speed rate of $25 \pm 3$ mm/minute on the terminal assembled in the housing.		0.5kgf min.
4-2-5	Pin Retention Force	Apply axial push force at the speed rate of $25 \pm 3$ mm/minute.		0.3kgf min.
4-2-6	Durability	When mated up to 50 cycles repeatedly Contact by the rate of 10 cycles per minute. Resistance		60mΩ max.
		Amplitude: 1.5mm P-P Sweep time: 10-55-10 Hz in 1 minute	Appearance	No Damage
4-2-7	Vibration	Duration: 2 hours in each X.Y.Z. axes	Contact Resistance	60mΩ max.
		(Based upon MIL-STD-202 Method 201A)	Discontinuity	1μsec. max.
		490m/s² {50G}, 3 strokes in each X.Y.Z. axes.	Appearance	No Damage
4-2-8	Physical Shock	(Based upon JIS C0041/MIL-STD-202 Method 213B Cond. A)	Contact Resistance	60mΩ max.
			Discontinuity	1μsec. max.





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#### 4-3.ENVIRONMENTAL PERFORMANCE AND OTHERS

Test Description		Procedure		Requirement
4-3-1 Temperature		Carrying rated current load.	Temperature	30°C max.
	Rise	(Based upon UL 498)	Rise	30 C max.
4-3-2	Heat	$85 \pm 2$ °C, 96 hours	Appearance	No Damage
	Resistance	(Based upon JIS C0021/MIL-STD-202	Contact	$60 \mathrm{m}\Omega$ max.
		Method 108A Cond. A)	Resistance	OUIIIS2 IIIax.
4-3-3	Cold	$-25 \pm 3$ °C, 96 hours	Appearance	No Damage
	Resistance	(Based upon JIS C0020)	Contact	$60 \mathrm{m}\Omega$ max.
			Resistance	OUIIISZ IIIAX.
		Temperature: $40 \pm 2^{\circ}$ C	Appearance	No Damage
		Relative Humidity: 90 ~ 95%	Contact	(Om) Omov
		Duration: 96 hours	Resistance	$60 \mathrm{m}\Omega$ max.
4-3-4	Humidity	(Based upon JIS C0022/MIL-STD-202	Insulation	50MO min
		Method 103B Cond. B)	Resistance	$50 \mathrm{M}\Omega$ min.
			Dielectric	
			Withstanding	Must meet 4-1-3
			Voltage	
		5 cycles of:		N. D.
4-3-5	Temperature	a) - 55°C 30 minutes	Appearance	No Damage
	Cycling	b) +85°C 30 minutes	Contact	(0, 0
	, ,	(Based upon JIS C0025)	Resistance	$60 \mathrm{m}\Omega$ max.
		$24 \pm 4$ hours exposure to a salt spray	A	N. D.
4-3-6	Salt Spray	from the $5 \pm 1\%$ solution at $35 \pm 2$ °C.	Appearance	No Damage
	1 ,	(Based upon JIS C0023/MIL-STD-202	Contact	(0, 0
		Method 101D Cond. B)	Resistance	$60 \mathrm{m}\Omega$ max.
		24 hours exposure to $50 \pm 5$ ppm.	Appearance	No Damage
4-3-7	SO <sub>2</sub> Gas	$SO_2$ gas at $40 \pm 2$ °C.	Contact	(0,,,0,,,,,,,,,,,,,,,,,,,,,,,,,,,,,,,,,
		-	Resistance	60m $Ω$ max.
		40 minutes exposure to NH <sub>3</sub> gas	Appearance	No Damage
4-3-8	NH3 Gas	evaporating from 28% Ammonia	Contact	60,000 000
		solution.	Resistance	$60 \mathrm{m}\Omega$ max.
		Soldering Time: $5 \pm 0.5$ sec.	Solder	95% of immersed
4-3-9	Solderability	Solder Temperature: $245 \pm 5$ °C	Wetting	area must show no
				voids, pin holes
		When reflowing		
4-3-10	Resistance	Refer to paragraph 6		
	to Soldering		A	No Dever-
	Heat	Solder iron method	Appearance	No Damage
		Soldering Time: $5 \pm 0.5$ sec.		
		Solder Temperature: 370°C ~ 400°C		
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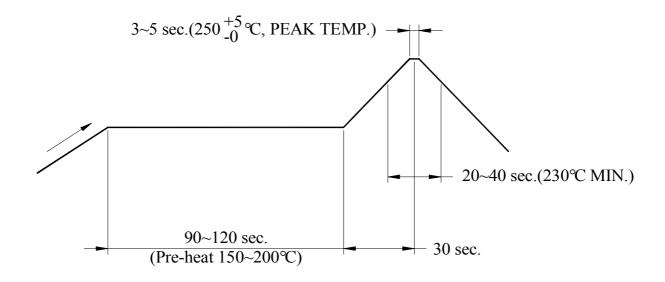
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#### 5.INSERTION/WITHDRAWAL FORCE:

No. of	Insertion	Withdrawal	
circuits	(kgf max.)	(kgf min.)	
Single	0.2	0.03	
8	1.6	0.20	
14	2.8	0.35	
20	4.0	0.50	
30	6.0	0.75	

#### **6.INFRARED REFLOW CONDITION:**



# TEMPERATURE CONDITION GRAPH (TEMPERATURE ON BOARD PATTERN SIDE)

NOTE: Please check the mount condition(reflow soldering condition) by your own devices beforehand, because the condition changes by the soldering devices, p.c.boards, and so on. No moisture treatment before reflow process.